

N-Channel Super Junction Power MOSFET $\ensuremath{\,\mathrm{IV}}$

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

Features

- Optimized body diode reverse recovery performance
- •Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ●ROHS compliant

Application

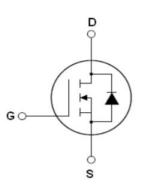
- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

Package Marking And Ordering Information

Device	Device Package	Marking
NCE70N1K1F	NCE70N1K1F TO-220F-3L	

Table 1. Absolute Maximum Ratings (Tc=25℃)

V_{DS min@Tjmax} 750 V R_{DS(ON)TYP}. 1000 mΩ I_D 4.5 A Qg 9.5 nC



Schematic diagram



TO-220F

Parameter	Symbol	Value	Unit		
Drain-Source Voltage (VGs=0V)	VDS	700	V		
Gate-Source Voltage (VDs=0V) ,AC (f>1 Hz)	Vgs	±30	V		
Gate-Source Voltage (VDs=0V) ,DC	Vgs	±20	V		
Continuous Drain Current at Tc=25°C	I _{D (DC)}	4.5	А		
Continuous Drain Current at Tc=100°C	I _{D (DC)}	3.15	А		
Pulsed drain current ^(Note 1)	DM (pluse)	13.5	А		
Maximum Power Dissipation(Tc=25℃)	PD	30.1	W		
Derate above 25°C		0.20	W/°C		
Single pulse avalanche current ^(Note 2)	I _{AS}	1.2	А		
Reverse diode dv/dt, $V_{DS} \leqslant 480 V, I_{SD} < I_D$	dv/dt	15	V/ns		
Drain Source voltage slope, $V_{DS} \leq 480 V$	dv/dt	50	V/ns		
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55+175	°C		



Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R _{thJC}	4.98	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	62	°C /W

Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250uA	700			V
Zero Gate Voltage Drain Current(Tc=25°C)	I _{DSS}	V _{DS} =700V,V _{GS} =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125°C)	I _{DSS}	V _{DS} =700V,V _{GS} =0V			50	μA
Gate-Body Leakage Current	I _{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$			±200	nA
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, I _D =250uA	3		4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =2.3A		1000	1100	mΩ
Dynamic Characteristics						
Gate Resistance	Rg	F=1MHZ, D-S short		36		Ω
Input Capacitance	Clss			311		pF
Output Capacitance	Coss	V_{DS} =50V, V_{GS} =0V,		14		pF
Reverse Transfer Capacitance	C _{rss}	F=1MHz		4		pF
Total Gate Charge	Qg			9.5		nC
Gate-Source Charge	Q _{gs}	V _{DS} =500V,I _D =2.3A,		3		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V		2.7		nC
Gate plateau voltage	Vgp			5.5		V
Switching times						
Turn-on Delay Time	t _{d(on)}			8		nS
Turn-on Rise Time	tr	V _{DD} =500V,I _D =2.3A, R _G =4Ω,V _{GS} =10V		5		nS
Turn-Off Delay Time	t _{d(off)}			48		nS
Turn-Off Fall Time	tf			8		nS
Source- Drain Diode Characteristics	·					
Source-drain current(Body Diode)	I _{SD}	T25°0			4.5	А
Pulsed-Source-drain current(Body Diode)	I _{SDM}	T _C =25°C			13.5	А
Forward on voltage	V _{SD}	Tj=25°C,I _{SD} =4.5A,V _{GS} =0V		0.9	1.1	V
Reverse Recovery Time	t _{rr}			170		nS
Reverse Recovery Charge	Qrr	Tj=25°C,I⊧2.3A,		0.46		uC
Peak reverse recovery current	Irrm	di/dt=100A/µs		5.5		Α

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25°C,VDD=50V,VG=10V, R_G=25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure1. Safe operating area

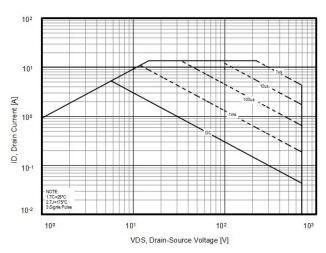


Figure3. Output characteristics

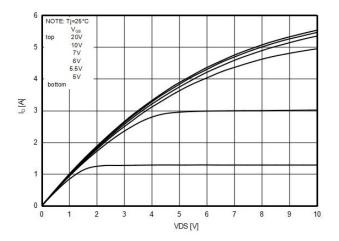


Figure5. Static drain-source on resistance

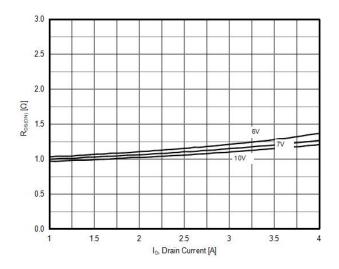


Figure2. Source-Drain Diode Forward Voltage

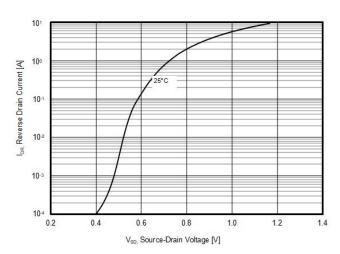


Figure4. Transfer characteristics

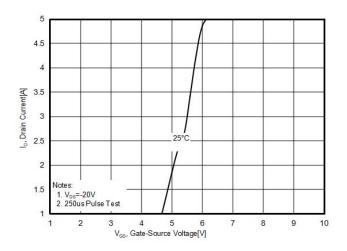


Figure6. RDS(ON) vs Junction Temperature

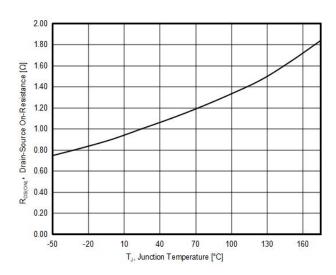




Figure 7. BV_{DSS} vs Junction Temperature

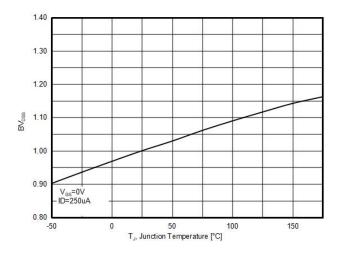


Figure9. Gate charge waveforms

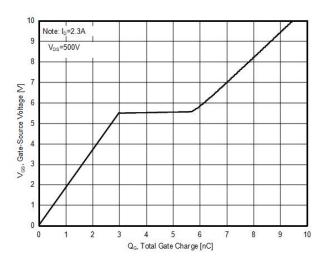


Figure8. Maximum I_D vs Junction Temperature

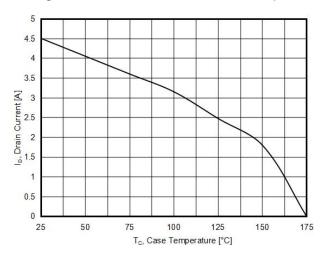
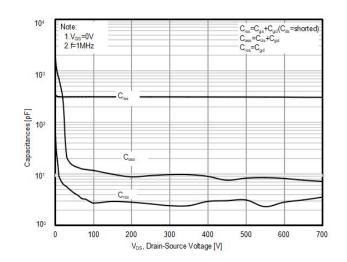


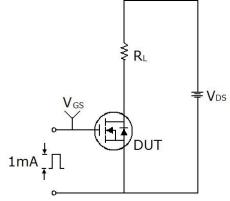
Figure10. Capacitance

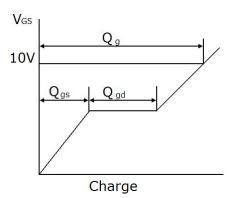




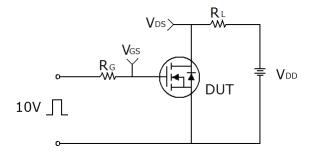
Test circuit

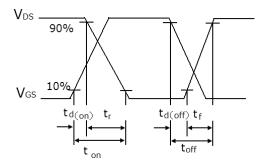
1) Gate charge test circuit & Waveform



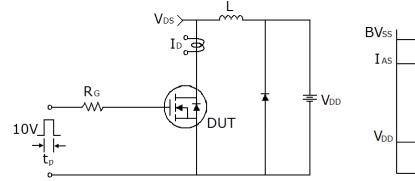


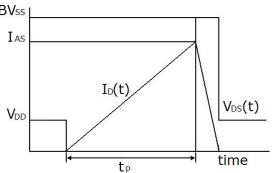
2) Switch Time Test Circuit:





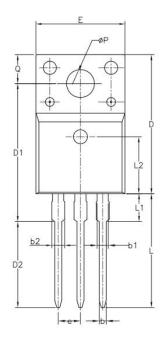
3) Unclamped Inductive Switching Test Circuit & Waveforms

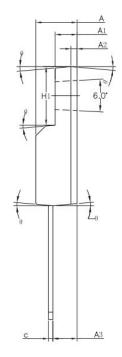






TO-220F-P Package Information





Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	4.50	4.83	0.177	0.190	
A1	2.34	2.74	0.092	0.108	
A2	0.7) REF	0.028 REF		
A3	2.56	2.93	0.101	0.115	
b	0.70	0.90	0.028	0.035	
b1	1.18	1.38	0.046	0.054	
b2		1.47		0.058	
С	0.45	0.60	0.018	0.024	
D	15.67	16.07	0.616	0.631	
D1	15.55	15.95	0.611	0.627	
D2	9.60	10.00	0.377	0.393	
E	9.96	10.36	0.391	0.407	
e	2.54 BSC		0.100 BSC		
H1	6.48	6.88	0.255	0.270	
L	12.68	13.28	0.498	0.522	
L1		3.50		0.138	
L2	6.50 REF		0.255 REF		
ØP	3.08	3.28	0.121	0.129	
Q	3.20	3.40	0.126	0.134	
θ1	1.0°	5.0°	1.00°	5.00°	



ATTENTION:

- Any and all NCE products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your NCE representative nearest you before using any NCE products described or contained herein in such applications.
- NCE assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all NCE products described or contained herein.
- Specifications of any and all NCE products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- NCE Power Semiconductor CO.,LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all NCE products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of NCE Power Semiconductor CO.,LTD.
- Information (including circuit diagrams and circuit parameters) herein is for example only ; it is not guaranteed for volume production. NCE believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the NCE product that you intend to use.
- This catalog provides information as of Mar. 2010. Specifications and information herein are subject to change without notice.